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Part Number: [0432028816](#)
Status: **Active**
Overview: [modular_plugs_jacks](#)
Description: Modular Jack, Right Angle, Low Profile, Shielded, No Panel Grounding Tabs, without Bottom Grounding Tab, Front Position PCB Ground Tab, 8/8

Documents:
[3D Model](#) [Product Specification PS-43202-001 \(PDF\)](#)
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

CSA LR19980
UL E107635

General

Product Family Modular Jacks/Plugs
Series [43202](#)
Component Type PCB Jack
Magnetic No
Overview [modular_plugs_jacks](#)
Performance Category 3
Power over Ethernet (PoE) N/A
Product Name RJ45

Physical

Color - Resin Black
Durability (mating cycles max) 500
Flammability 94V-0
Inverted / Top Latch No
Lightpipes/LEDs None
Material - Metal Brass, Phosphor Bronze
Material - Plating Mating Gold
Material - Plating Termination Tin
Material - Resin High Temperature Thermoplastic
Orientation Right Angle (Side Entry)
PCB Retention Yes
PCB Thickness Recommended (in) 0.062 In
PCB Thickness Recommended (mm) 1.60 mm
Packaging Type Tray
Panel Mount With Flange
Pitch - Mating Interface (in) 0.050 In
Pitch - Mating Interface (mm) 1.27 mm
Plating min: Mating (µin) 50
Plating min: Mating (µm) 1.25
Plating min: Termination (µin) 100
Plating min: Termination (µm) 2.5
Ports 1
Positions / Loaded Contacts 8/8
Surface Mount Compatible (SMC) Yes
Temperature Range - Operating -40°C to +85°C
Termination Interface: Style Through Hole
Wire/Cable Type N/A

Electrical

Current - Maximum per Contact 1.5A
Grounding to PCB Yes

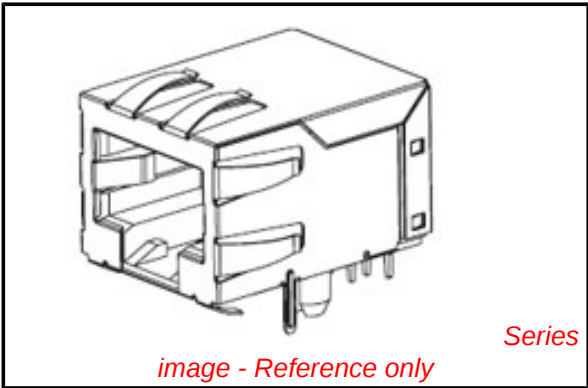


image - Reference only

Series

EU RoHS
ELV and RoHS
Compliant
REACH SVHC
Contains SVHC: No
Halogen-Free
Status
Not Halogen-Free

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series
[43202Series](#)

Mates With
FCC 68 Plugs

Grounding to Panel	None
Shielded	Yes
Voltage - Maximum	125V
Solder Process Data	
Duration at Max. Process Temperature (seconds)	5
Lead-free Process Capability	Wave Capable (TH only)
Max. Cycles at Max. Process Temperature	1
Process Temperature max. C	260
Material Info	
Reference - Drawing Numbers	
Packaging Specification	PK-43202-004
Product Specification	PS-43202-001, RPS-43202-002
Sales Drawing	SDA-43202

This document was generated on 06/07/2010

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NOTES:

1) MATERIAL:

HOUSING: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: SEE SHEETS 5 AND 6
INSULATOR: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: SEE SHEETS 5 AND 6
TERMINALS: PHOSPHOR BRONZE, .012/ 0.30 THICK
SHIELD: BRASS, .007/ 0.18 THICK

2) FINISH:

TERMINALS:

A = SELECT GOLD IN CONTACT AREA: 50 MICROINCHES / 1.27 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES / 2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES / 1.27 MICROMETERS MIN.
B = SELECT GOLD IN CONTACT AREA: 30 MICROINCHES / 0.76 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES / 2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES / 1.27 MICROMETERS MIN.
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS
DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD
IN THE PC TAILS AND/OR SHIELD.

SHIELD:

100 MICROINCHES / 2.54 MICROMETERS NICKEL OVER 50 MICROINCHES / 1.27
MICROMETERS COPPER UNDERPLATE PCB GROUND TABS DIPPED IN TIN

3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43202.

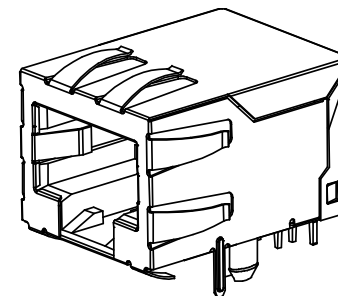
4) PACKAGING SPECIFICATION:

UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS
PER MOLEX PACKAGING SPECIFICATION PK-43202-003.
UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN TUBES
PER MOLEX PACKAGING SPECIFICATION PK-43202-005.
SHIELDED CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS
PER MOLEX PACKAGING SPECIFICATION PK-43202-004.

5) SEE SHEETS 7 - 9 FOR P.C. BOARD LAYOUTS.

6) CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.

7) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.



SHIELDED MODULAR JACK
SHOWN WITH PANEL GROUND
OPTION 'D' AND FRONT
PCB GROUND TABS.

DRAWING LEGEND

SHEET 1- NOTES, DRAWING LEGEND
SHEET 2- SHIELDED MODULAR JACK W/ BOTTOM GROUND TABS
SHEET 3- SHIELDED MODULAR JACK W/O BOTTOM GROUND TABS
SHEET 4- UNSHIELDED MODULAR JACK
SHEET 5- PART NUMBER CHARTS
SHEET 6- PART NUMBER CHARTS
SHEET 7- FOOTPRINT LAYOUT FOR 4 POSITION HOUSING
SHEET 8- FOOTPRINT LAYOUT FOR 6 POSITION HOUSING
SHEET 9- FOOTPRINT LAYOUT FOR 8 POSITION HOUSING

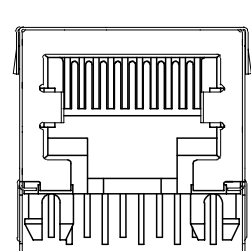
OBS COLORED JACKS EC NO: UCP2008-1189 DRAWN:JBELL 2007/11/30 CHKD:LSCHMIDT 2008/02/20 APPR:FSM/TH 2008/03/04	QUALITY SYMBOLS ▽=0 ▽=0	DESCRIPTION REV	L4	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	 THIRD ANGLE PROJECTION	SHEET NO. 1 OF 9	
					mm	INCH	DRAWN BY JTR	DATE 1993/03/31	TITLE ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY MOLEX INCORPORATED			
				4 PLACES	± ---	± ---	CHECKED BY	DATE 1993/03/31				
				3 PLACES	± ---	± .010	JTR	DATE 1993/03/31				
				2 PLACES	± 0.25	± .014	APPROVED BY	DATE 1993/03/31				
				1 PLACE	± 0.36	± ---	RAS	DATE 1993/03/31				
				ANGULAR ±1/2°		MATERIAL NO.	DOCUMENT NO.	SDA-43202				
				DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHTS 5&6						
						SIZE	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

9	L2
8	L2
7	L2
6	L4
5	L
4	K2
3	L1
2	L1
1	L4
SH	REV

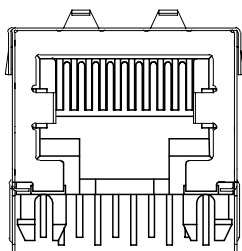
SHIELDED MODULAR JACK W/O BOTTOM GROUND TABS

SIZE 8, LOADED 10 VERSION SHOWN

SIDE/TOP GROUND TAB OPTIONS FOR SHIELDS



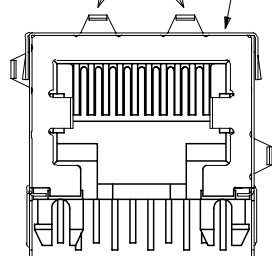
OPTION "E"
NO TOP OR SIDE TABS



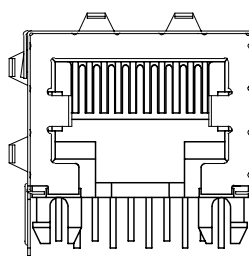
OPTION "F"
TOP TABS

OPTIONAL TOP GROUND TABS

SHIELDED MODULAR JACK ASSEMBLY
SEE SHEET 6 FOR MATERIAL NO.

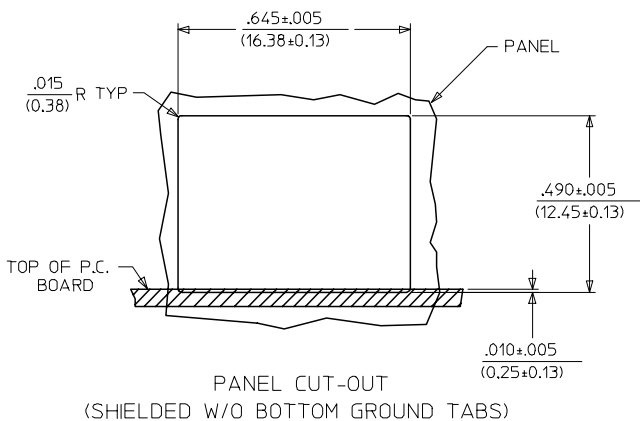


OPTION "G"
TOP AND STAGGERED SIDE TABS

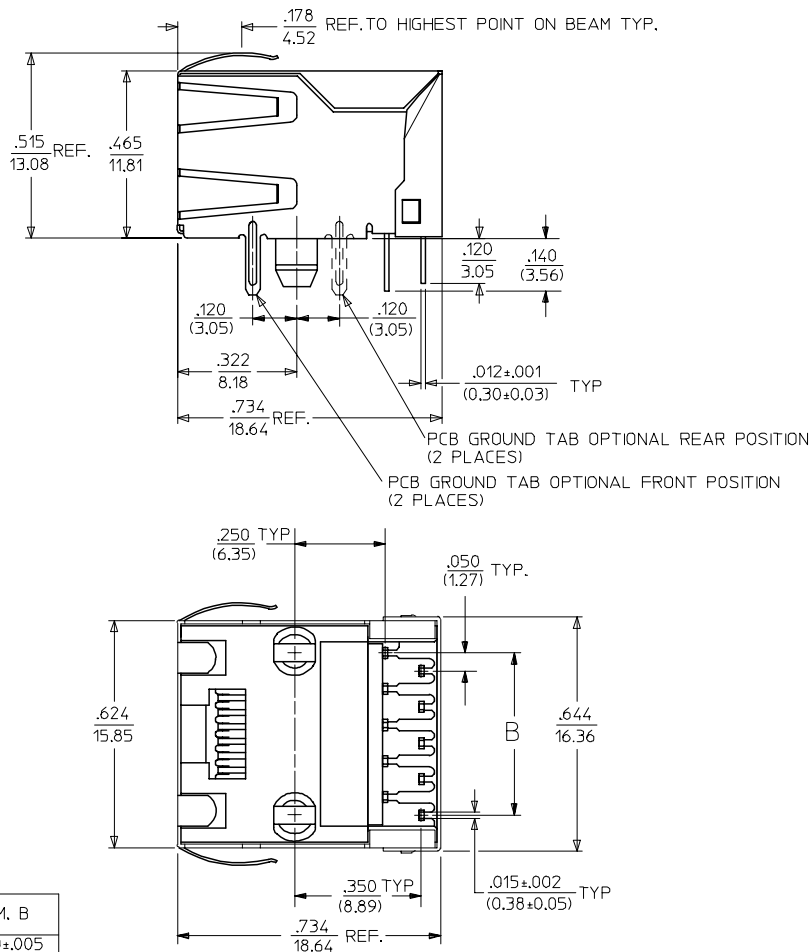


OPTION "H"
TOP AND SIDE TABS

OPTIONAL SIDE
GROUND TABS
(2 PLACES)



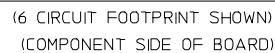
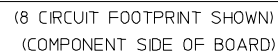
HOUSING SIZE	CIRCUIT SIZE	DIM. B
8	10	.450±.005 (11.43±.13)
8	8	.350±.005 (8.89±.13)



SEE SHEET ONE EC NO: UCP2004-1888 DRAWN: SCHMIDT 2004/03/31 CHKD: SCHMIDT 2004/03/31 APPR: FSMITH 2004/03/31 L1	DESCRIPTION	QUALITY SYMBOLS		GENERAL TOLERANCES (UNLESS SPECIFIED)			SCALE 4:1	DESIGN UNITS INCH		THIRD ANGLE PROJECTION	REVISE ON CAD ONLY	
					mm	INCH	DIMENSION STYLE			TITLE		
							IN/MM			ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY		
					4 PLACES ± ---	± ---	DRAWN BY	DATE	MOLEX MOLEX INCORPORATED			
					3 PLACES ± ---	± .010	JTR	1993/03/31				
					2 PLACES ± 0.25	± .014	CHECKED BY	DATE	MATERIAL NO. DOCUMENT NO. SHEET NO.			
					1 PLACE ± 0.36	± ---	JTR	1993/03/31				
					ANGULAR ± 1/2°		APPROVED BY	DATE	SEE SHT 6 SDA-43202 3 OF 9			
	DRAFT WHERE APPLICABLE		RAS	1993/03/31	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							
	MUST REMAIN WITHIN DIMENSIONS											

	13	12	11	10	9	8	7	6	5	4	3	2	1		
J	SHIELDED MODULAR JACKS W/O BOTTOM GROUND TABS (SHEET 3)							UNSHIELDED MODULAR JACKS- (SHEET 4)							J
	ASSEMBLY MATERIAL NUMBER	CONNECTOR SIZE	NUMBER OF CIRCUITS	SIDE/TOP PANEL GROUND TAB OPTION	PCB GROUND TAB OPTION	TERMINAL PLATING OPTION	PACKAGING	HOUSING COLOR	ASSEMBLY MATERIAL NUMBER	CONNECTOR SIZE	NUMBER OF CIRCUITS	TERMINAL PLATING OPTION	KEYING OPTION	PACKAGING OPTION	HOUSING COLOR
	43202-8800	8	10	E	FRONT POSITION	A	TRAY	BLACK	43202-4101	4	4	A	NO	TRAY	BLACK
I	43202-8801	8	10	F	FRONT POSITION	A	TRAY		43202-4104	4	2	A	NO	TRAY	
	43202-8802	8	10	G	FRONT POSITION	A	TRAY		43202-6101	6	6	A	NO	TRAY	
	43202-8803	8	10	H	FRONT POSITION	A	TRAY		43202-6102	6	6	B	NO	TRAY	
	43202-8808	8	10	E	REAR POSITION	A	TRAY		43202-6104	6	4	A	NO	TRAY	
	43202-8809	8	10	F	REAR POSITION	A	TRAY		43202-6105	6	4	B	NO	TRAY	
H	43202-8810	8	10	G	REAR POSITION	A	TRAY		43202-6107	6	2	A	NO	TRAY	
	43202-8811	8	10	H	REAR POSITION	A	TRAY		43202-6110	6	6	B	NO	TUBE	
	43202-8816	8	8	E	FRONT POSITION	A	TRAY		43202-8101	8	10	A	NO	TRAY	
	43202-8817	8	8	F	FRONT POSITION	A	TRAY		43202-8104	8	8	A	NO	TRAY	
	43202-8818	8	8	G	FRONT POSITION	A	TRAY		43202-8105	8	8	B	NO	TRAY	
	43202-8819	8	8	H	FRONT POSITION	A	TRAY		43202-8113	8	8	A	YES	TRAY	
	43202-8824	8	8	E	REAR POSITION	A	TRAY		43202-8116	8	6	A	NO	TRAY	
	43202-8825	8	8	F	REAR POSITION	A	TRAY		43202-8119	8	4	A	NO	TRAY	
G	43202-8826	8	8	G	REAR POSITION	A	TRAY		43202-8122	8	2	A	NO	TRAY	
	43202-8827	8	8	H	REAR POSITION	A	TRAY		43202-8504	8	8	A	NO	TUBE	
									43202-8513	8	8	A	YES	TUBE	
F															F
E															E
D															D
C															C
B															B
A															A
tb_frame_C_P_ME_T Rev. E 2006/04/15															
	12	11	10	9	8	7	6	5	4	3	2	1			

OBS COLORED JACKS EC NO: UCP2008-1189 DRWN:JBELL 2007/11/30 CHKD:LSCHMIDT 2008/02/20 APPR:FSMITH 2008/03/04	QUALITY SYMBOLS ▽=0 ▽=0	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION		
			4 PLACES ± --- ± --- 3 PLACES ± --- ± .010 2 PLACES ± 0.25 ± .014 1 PLACE ± 0.36 ± --- ANGULAR ±1/2°	mm	INCH	DRAWN BY JBS	DATE 2000/10/03	TITLE ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY			
						CHECKED BY BW	DATE 2000/10/03				
						APPROVED BY BW	DATE 2000/10/03				
						MATERIAL NO. SEE CHART	DOCUMENT NO. SDA-43202				
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE C	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								
							SHEET NO. 6 OF 9				



NOTES:
1. RECOMMENDED PCB THICKNESS: .062±.005/(1.57±0.13)

ADD PCB THICKNESS

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

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